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Acer recalls some
Aspire Timeline
laptops
Acer

Some Acer Aspire Laptops Recalled Due to Overheating

Models manufactured before September 15

Over the years, there have been a series of headlines regarding laptops from various system vendors that had been recalled due to various reasons, most of which had to do with overheating of a certain hardware component. It appears that, although the manufacturing technology has evolved significantly, enabling low-power, more compact components, these overheating issues continue to make themselves noticed in some of the latest laptops on the market. Such is the case with a couple of Aspire models, from one of the world's leading vendors of laptops, Acer, which has just issued a recall for said machines. According to a dedicated webpage on the company's custom-care website, there are a couple of Aspire models that may overheat under specific conditions. The list of affected units includes the AS3410, AS3810T, AS3810TG, AS3810TZ and AS3810TZG models, which were manufactured prior to September 15, 2009. Apparently, in these units, the microphone cable may overheat "when extreme pressure is applied repeatedly to the left palm rest." The units, Acer informs, could become deformed and the system may malfunction, which is why users are advised to check if their laptops are among the listed models and take advantage of the recall program. Acer has announced that customers who will notice the aforementioned issues, or will check to see if their models are listed on this [website](#), will be able to take advantage of said recall program. The company has promised to proactively replace the microphone and the affected units, consequently eliminating overheating. The listed models are part of Acer's line of Timeline 13.3-inch CULV-based ultraportable laptops, providing end-user with an alternative to other CULV-based ultra-thin laptops currently available on the market. These systems are designed to adopt a thin and light form factor, with the manufacturer being forced to cramp everything into a thinner chassis.